TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

### TC74VHC157F,TC74VHC157FN,TC74VHC157FT,TC74VHC157FK

#### **Quad 2-Channel Multiplexer**

The TC74VHC157 is an advanced high speed CMOS QUAD 2-CHANNEL MULTIPLEXER fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It consists of four 2-input digital multiplexers with common select and strobe inputs.

When the STROBE input is held "H" level, selection of data is inhibited and all the outputs become "L" level.

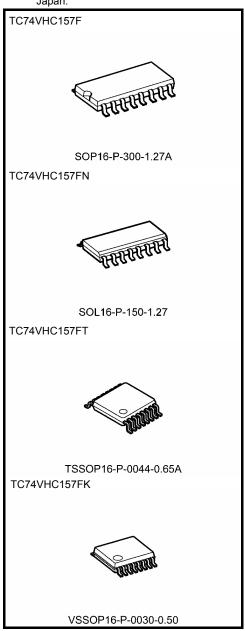
The SELECT decoding determines whether the A or B inputs get routed to their corresponding Y outputs.

An Input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and on two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

- High speed:  $t_{pd} = 4.1 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- · Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC \text{ (opr)}} = 2 \text{ V to } 5.5 \text{ V}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS157

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight

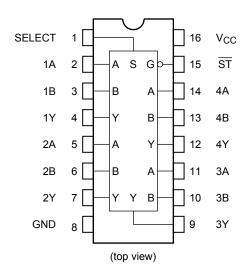
 SOP16-P-300-1.27A
 : 0.18 g (typ.)

 SOL16-P-150-1.27
 : 0.13 g (typ.)

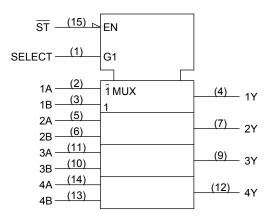
 TSSOP16-P-0044-0.65A
 : 0.06 g (typ.)

 VSSOP16-P-0030-0.50
 : 0.02 g (typ.)

## **Pin Assignment**



## **IEC Logic Symbol**

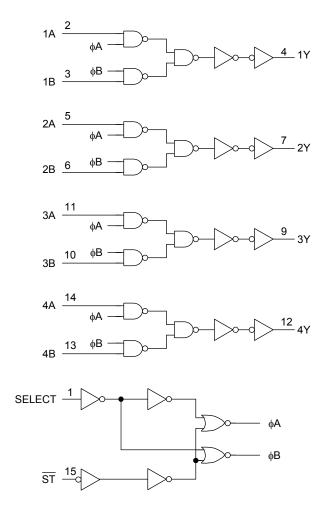


### **Truth Table**

	Inputs	Output		
ST	SELECT	Α	В	Output
Н	Х	Х	Х	L
L	L	L	Х	L
L	L	Н	Х	Н
L	Н	Х	L	L
L	Н	Х	Н	Н

X: Don't care

### **System Diagram**



#### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±50	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

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Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	−40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)	ns/V	
input rise and rail time	ui/uv	0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )		

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition $V_{CC}\left(V\right)$		Ta = 25°C			Ta = −40 to 85°C		Unit	
Sharastensus	Cymbol			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High-level input		_		2.0	1.50	_	_	1.50	_	
voltage	V <sub>IH</sub>			3.0 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	V
Low-level input				2.0	_	_	0.50	_	0.50	
voltage	Low-level input voltage		_	3.0 to 5.5	_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	V
	Voн	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	1.9	2.0	_	1.9	_	
			I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	_	
High-level output voltage				4.5	4.4	4.5	_	4.4	_	V
-			I <sub>OH</sub> = −4 mA	3.0	2.58	-	_	2.48	_	
			I <sub>OH</sub> = -8 mA	4.5	3.94	-	_	3.80	_	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	_	0.0	0.1	_	0.1	
			I <sub>OL</sub> = 50 μA	3.0	_	0.0	0.1	_	0.1	
Low-level output voltage				4.5	_	0.0	0.1	_	0.1	V
, and the second			I <sub>OL</sub> = 4 mA	3.0	_	-	0.36	_	0.44	
			I <sub>OL</sub> = 8 mA	4.5	_	_	0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 or GND		0 to 5.5	_	_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	_	40.0	μΑ



#### AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	T Symbol		est Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	5,26.		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
		_	3.3 ± 0.3	15	_	6.2	9.7	1.0	11.5	
Propagation delay time	$t_{pLH}$		3.3 ± 0.3	50	_	8.7	13.2	1.0	15.0	ns
(A, B-Y)	$t_{pHL}$		5.0 ± 0.5	15	_	4.1	6.4	1.0	7.5	
			3.0 ± 0.3	50	_	5.6	8.4	1.0	9.5	
		_	3.3 ± 0.3	15	_	8.4	13.2	1.0	15.5	- ns
Propagation delay time	t <sub>pLH</sub> t <sub>pHL</sub>			50	_	10.9	16.7	1.0	19.0	
(SELECT-Y)			5.0 ± 0.5	15	_	5.3	8.1	1.0	9.5	
,				50	_	6.8	10.1	1.0	11.5	
	t <sub>pLH</sub>	_	3.3 ± 0.3	15	_	8.7	13.6	1.0	16.0	
Propagation delay time				50	_	11.2	17.1	1.0	19.5	ns
(ST-Y)	$t_{pHL}$		5.0 ± 0.5	15	_	5.6	8.6	1.0	10.0	115
				50	_	7.1	10.6	1.0	12.0	
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note)	_	20	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

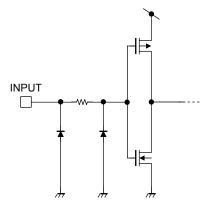
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 (per bit)$ 

#### Noise Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta =	Ta = 25°C	
Characteristics	Syllibol		V <sub>CC</sub> (V)	Тур.	Limit	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.3	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.3	-0.8	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

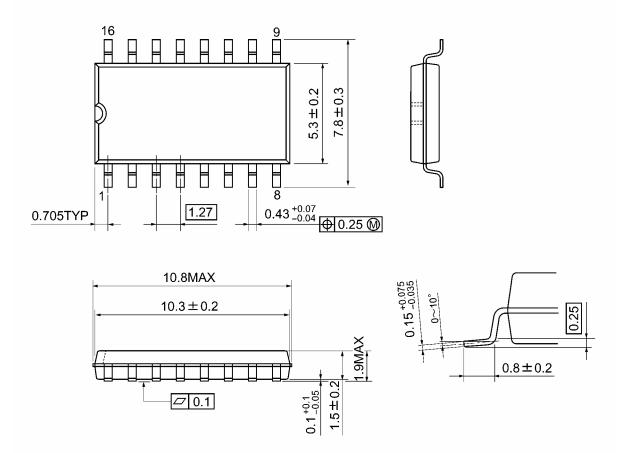
# **Input Equivalent Circuit**



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## **Package Dimensions**

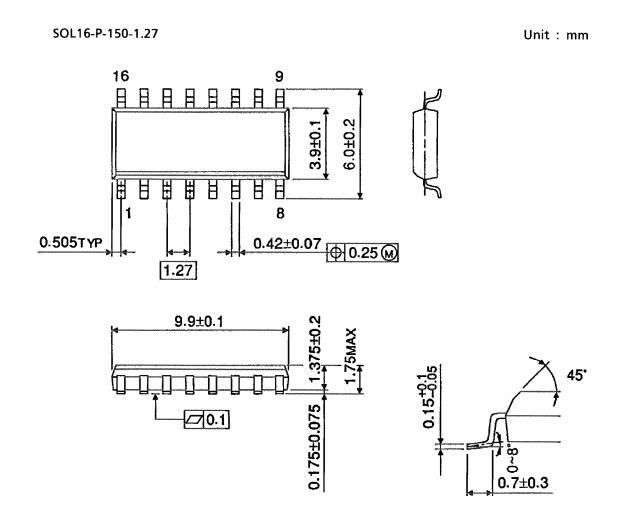
SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)



## **Package Dimensions (Note)**



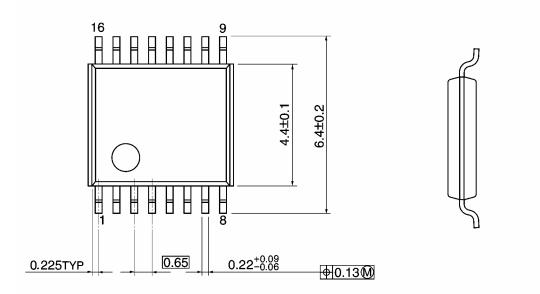
8

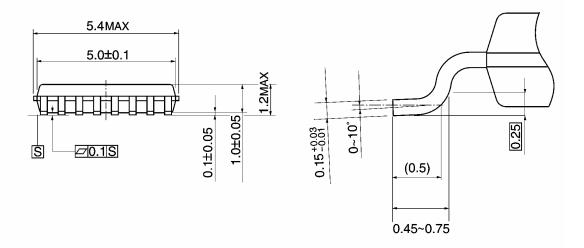
Note: This package is not available in Japan.

Weight: 0.13 g (typ.)

## **Package Dimensions**

TSSOP16-P-0044-0.65A Unit: mm



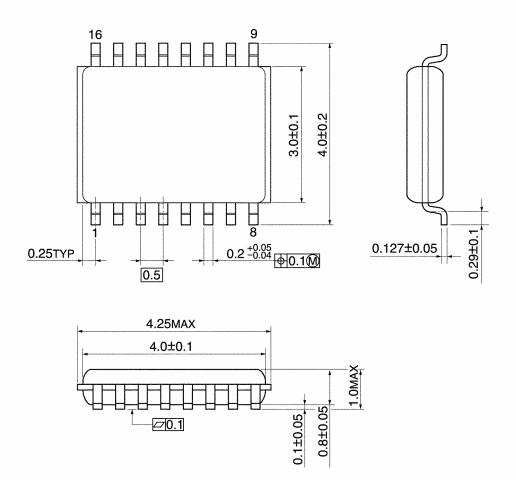


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Weight: 0.06 g (typ.)

## **Package Dimensions**

VSSOP16-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

#### **RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

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